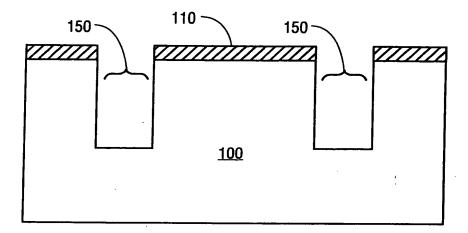
Blakely, Sokoloff, Taylor & Zafman LLP (310) 207-3800
Title: A THERMAL CONDUCTING TRENCH IN A SEMICONDUCTOR
STRUCTURE AND METHOD FOR FORMING THE SAME
1st Named Inventor: Chunlin Liang
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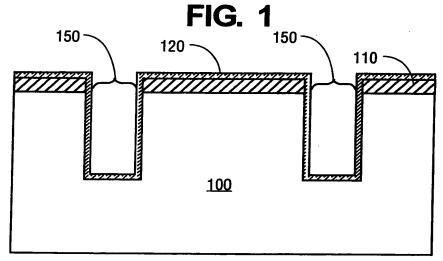


FIG. 2

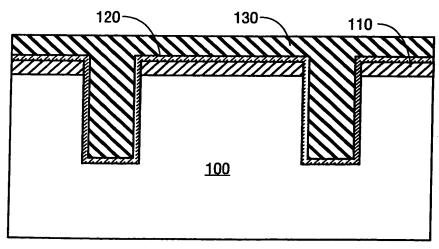


FIG. 3

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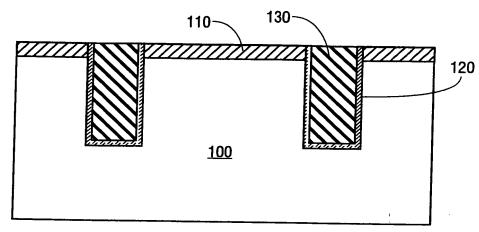


FIG. 4

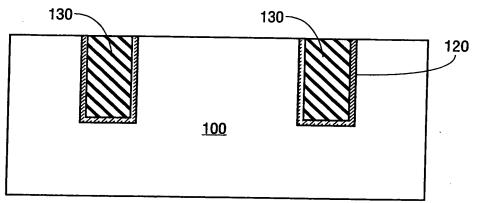


FIG. 5

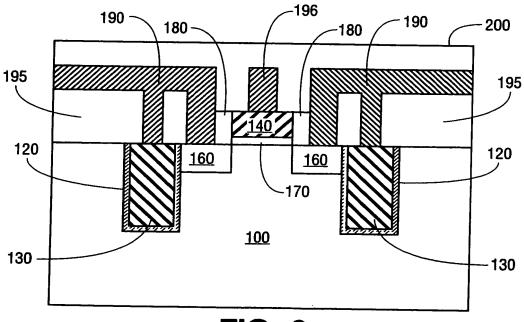


FIG. 6

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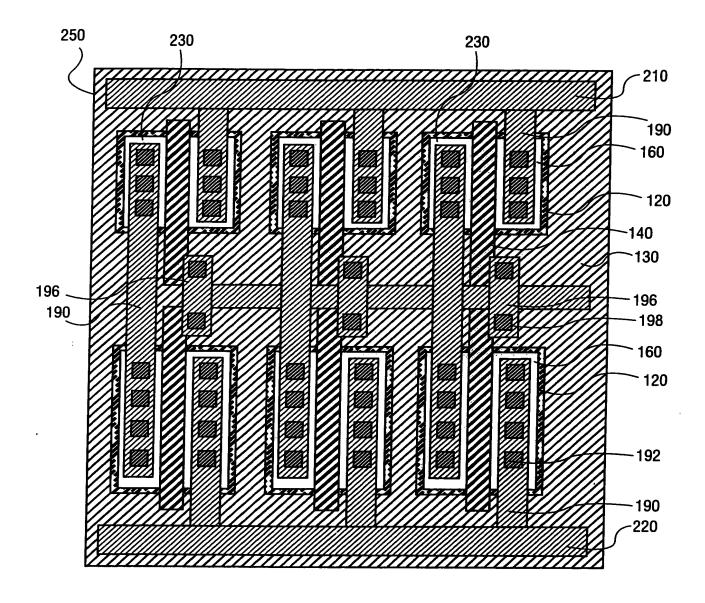


FIG. 7

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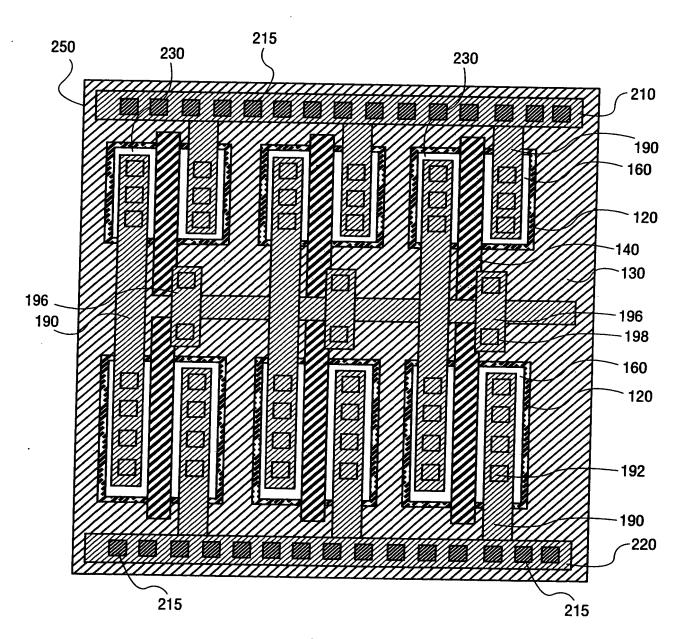


FIG. 8

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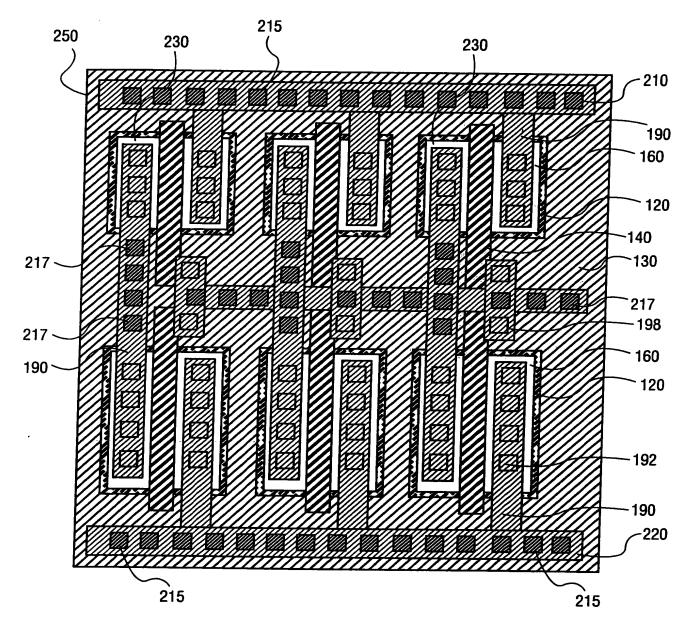
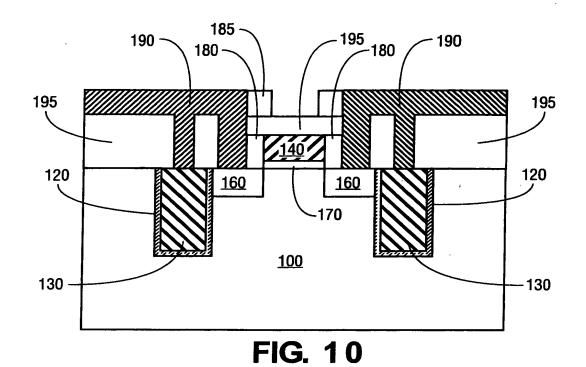
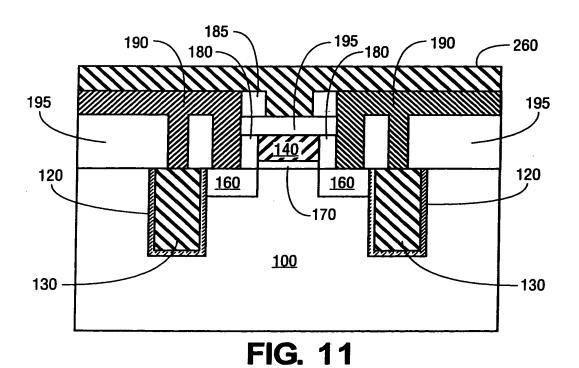


FIG. 9

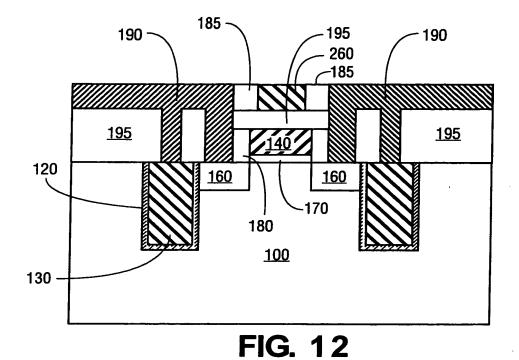
1st Named Inventor: Chunlin Liang Express Mail No.: EV339905632US

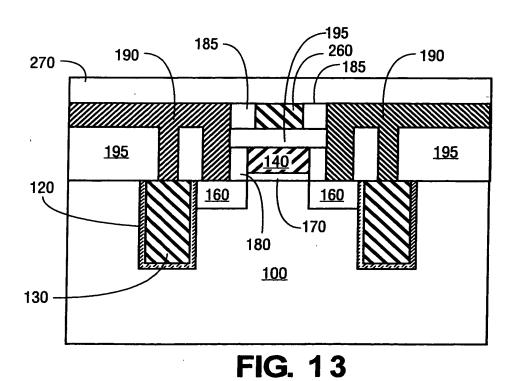
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